

PQEZ-XXS-X-094/023

No. of Contacts	DIMENSIONS	
	A	B
12	10.00	12.40
14	12.00	14.40
16	14.00	16.40
18	16.00	18.40
20	18.00	20.40
22	20.00	22.40
24	22.00	24.40
26	24.00	26.40
28	26.00	28.40
30	28.00	30.40
32	30.00	32.40
34	32.00	34.40
36	34.00	36.40
38	36.00	38.40
40	38.00	40.40
42	40.00	42.40
44	42.00	44.40
46	44.00	46.40
48	46.00	48.40
50	48.00	50.40
52	50.00	52.40
54	52.00	54.40
56	54.00	56.40
58	56.00	58.40
60	58.00	60.40

Number of Contacts

Contact Plating

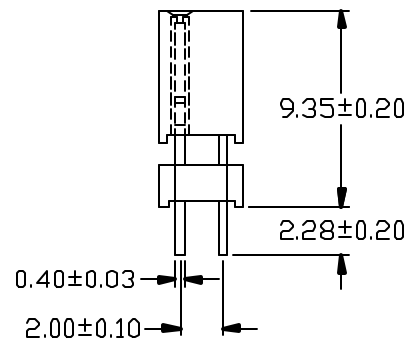
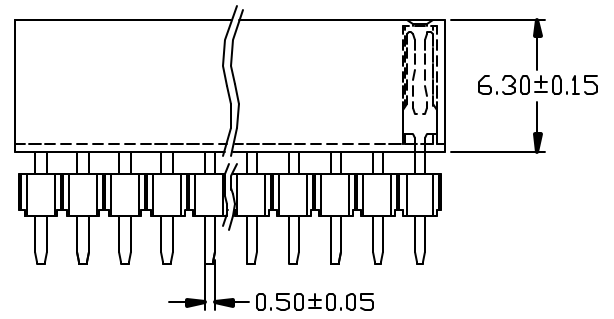
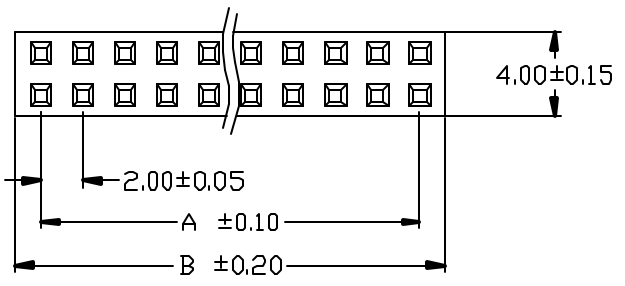
Definition	Code		
⊙ Tin plated:	A		
⊙ Gold plated:			
flash	B	15μ"	F
10μ"	E	30μ"	J
⊙ Duplex plating:			
flash	K	15μ"	P
10μ"	N	30μ"	U
⊙ Standard	K		

SPECIFICATIONS

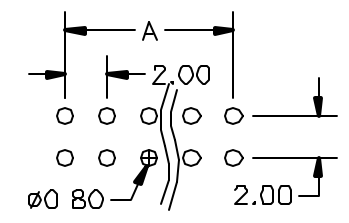
Current Rating: 1 Amp
 Insulator resistance: 5000 Megohms min.
 Contact resistance: 20 m ohms max.
 Dielectric withstanding: AC 500 V
 Operating Temperature: -40°~+105°C
 Max Processing Temp: 230° for 30 seconds
 Contact Material: Phosphor Bronze.
 Insulator Material: High Temperature Thermoplastic, UL 94V-0

Finish: Tin, Gold or Duplex plated
 ⊙ Standard: Duplex plated
 ⊙ Note:
 Duplex plating: gold plated on contact area, Tin on solder area

*Product specifications are subject to change without notice Please contact sales office for further confirmation.



Recommended P.C.Board Hole Layout



GENERAL TOLERANCE		SCALE	3=1	DRAWN	DATE	-03-02*	DWG. NO.	TITLE	REV.
XX. ±	XXX. ±	UNIT	MM	CHECK	DATE	-03-02*	F:\DWG\CDWG\PQE\PQEZ0L.DWG	PQEZ Series	1.0
X. ±	.XXX ±	SIZE	A4	APPROVE	DATE	-03-02*	PARTS NO.		SHEET
.X ±	.X* ±						PQEZ-XXS-X-094/023		1/2
XX ±	.X* ±								